

AKU B.E./B.Tech CSE Sem 2 syllabus

Engineering Graphics & Design

PAPER CODE - 100102 || 100202 ESC ENGINEERING GRAPHICS & DESIGN

CREDIT:3

MODULE 1: INTRODUCTION TO ENGINEERING DRAWING
PRINCIPLES OF ENGINEERING GRAPHICS AND THEIR
SIGNIFICANCE, USAGE OF DRAWING INSTRUMENTS, LETTERING,
CONIC SECTIONS INCLUDING THE RECTANGULAR HYPERBOLA
(GENERAL METHOD ONLY); CYCLOID, EPICYCLOID,
HYPOCYCLOID AND INVOLUTE; SCALES - PLAIN, DIAGONAL AND
VERNIER SCALES

MODULE 2: ORTHOGRAPHIC PROJECTIONS

PRINCIPLES OF ORTHOGRAPHIC PROJECTIONS-CONVENTIONS - PROJECTIONS OF POINTS AND LINES INCLINED TO BOTH PLANES; PROJECTIONS OF PLANES INCLINED PLANES - AUXILIARY PLANES

MODULE 3: PROJECTIONS OF REGULAR SOLIDS

THOSE INCLINED TO BOTH THE PLANES- AUXILIARY VIEWS; DRAW SIMPLE ANNOTATION, DIMENSIONING AND SCALE. FLOOR PLANS THAT INCLUDE: WINDOWS, DOORS, AND FIXTURES SUCH AS WC, BATH, SINK, SHOWER, ETC.

MODULE 4: SECTIONS AND SECTIONAL VIEWS OF RIGHT ANGULAR SOLIDS

COVERING, PRISM, CYLINDER, PYRAMID, CONE – AUXILIARY VIEWS; DEVELOPMENT OF SURFACES OF RIGHT REGULAR SOLIDS- PRISM, PYRAMID, CYLINDER AND CONE; DRAW THE SECTIONAL ORTHOGRAPHIC VIEWS OF GEOMETRICAL SOLIDS, OBJECTS FROM INDUSTRY AND DWELLINGS (FOUNDATION TO

SLAB ONLY)

MODULE 5: ISOMETRIC PROJECTIONS

PRINCIPLES OF ISOMETRIC PROJECTION – ISOMETRIC SCALE, ISOMETRIC VIEWS, CONVENTIONS; ISOMETRIC VIEWS OF LINES, PLANES, SIMPLE AND COMPOUND SOLIDS; CONVERSION OF ISOMETRIC VIEWS TO ORTHOGRAPHIC VIEWS AND VICE-VERSA, CONVENTIONS

MODULE 6: OVERVIEW OF COMPUTER GRAPHICS

LISTING THE COMPUTER TECHNOLOGIES THAT IMPACT ON GRAPHICAL COMMUNICATION, DEMONSTRATING KNOWLEDGE OF THE THEORY OF CAD SOFTWARE [SUCH AS: THE MENU SYSTEM, TOOLBARS (STANDARD, OBJECT PROPERTIES, DRAW, MODIFY AND DIMENSION), DRAWING AREA (BACKGROUND, CROSSHAIRS, COORDINATE SYSTEM), DIALOG BOXES AND WINDOWS, SHORTCUT MENUS (BUTTON BARS), THE COMMAND LINE (WHERE APPLICABLE), THE STATUS BAR, DIFFERENT METHODS OF ZOOM AS USED IN CAD, SELECT AND ERASE OBJECTS.; ISOMETRIC VIEWS OF LINES, PLANES, SIMPLE AND COMPOUND SOLIDS]

MODULE 7: CUSTOMISATION& CAD DRAWING

CONSISTING OF SET UP OF THE DRAWING PAGE AND THE PRINTER, INCLUDING SCALE SETTINGS, SETTING UP OF UNITS AND DRAWING LIMITS; ISO AND ANSI STANDARDS FOR COORDINATE DIMENSIONING AND TOLERANCING; ORTHOGRAPHIC CONSTRAINTS, SNAP TO OBJECTS MANUALLY AND AUTOMATICALLY; PRODUCING DRAWINGS BY USING VARIOUS COORDINATE INPUT ENTRY METHODS TO DRAW STRAIGHT LINES, APPLYING VARIOUS WAYS OF DRAWING CIRCLES.

MODULE 8: ANNOTATIONS, LAYERING & OTHER FUNCTIONS COVERING APPLYING DIMENSIONS TO OBJECTS, APPLYING ANNOTATIONS TO DRAWINGS; SETTING UP AND USE OF LAYERS, LAYERS TO CREATE DRAWINGS, CREATE, EDIT AND USE CUSTOMIZED LAYERS; CHANGING LINE LENGTHS THROUGH MODIFYING EXISTING LINES (EXTEND/LENGTHEN); PRINTING DOCUMENTS TO PAPER USING THE PRINT COMMAND; ORTHOGRAPHIC PROJECTION TECHNIQUES; DRAWING SECTIONAL VIEWS OF COMPOSITE RIGHT REGULAR GEOMETRIC SOLIDS AND PROJECT THE TRUE SHAPE OF THE SECTIONED SURFACE; DRAWING ANNOTATION, COMPUTER-AIDED DESIGN

(CAD) SOFTWARE MODELING OF PARTS AND ASSEMBLIES. PARAMETRIC AND NON-PARAMETRIC SOLID, SURFACE, AND WIREFRAME MODELS. PART EDITING AND TWO-DIMENSIONAL DOCUMENTATION OF MODELS. PLANAR PROJECTION THEORY, INCLUDING SKETCHING OF PERSPECTIVE, ISOMETRIC, MULTIVIEW, AUXILIARY, AND SECTION VIEWS. SPATIAL VISUALIZATION EXERCISES. DIMENSIONING GUIDELINES, TOLERANCING TECHNIQUES; DIMENSIONING AND SCALE MULTI VIEWS OF DWELLING.

MODULE 9: DEMONSTRATION OF A SIMPLE TEAM DESIGN PROJECT THAT ILLUSTRATES

GEOMETRY AND TOPOLOGY OF ENGINEERED COMPONENTS: CREATION OF ENGINEERING MODELS AND THEIR PRESENTATION IN STANDARD 2D BLUEPRINT FORM AND AS 3D WIRE- FRAME AND SHADED SOLIDS; MESHED TOPOLOGIES FOR ENGINEERING ANALYSIS AND TOOL- PATH GENERATION FOR COMPONENT MANUFACTURE; GEOMETRIC DIMENSIONING AND TOLERANCING; USE OF SOLID-MODELING SOFTWARE FOR CREATING ASSOCIATIVE MODELS AT THE COMPONENT AND ASSEMBLY LEVELS. FLOOR PLANS THAT INCLUDE: WINDOWS, DOORS, AND FIXTURES SUCH AS WC, BATH, SINK, SHOWER, ETC. APPLYING COLOUR CODING ACCORDING TO BUILDING DRAWING PRACTICE; DRAWING SECTIONAL ELEVATION SHOWING FOUNDATION TO CEILING; INTRODUCTION TO BUILDING INFORMATION MODELLING (BIM).

SUGGESTED TEXT/REFERENCE BOOKS:

- BHATT N.D., PANCHAL V.M. & INGLE P.R., (2014), ENGINEERING DRAWING, CHAROTAR PUBLISHING HOUSE
- SHAH, M.B. &RANA B.C. (2008), ENGINEERING DRAWING AND COMPUTER GRAPHICS, PEARSON EDUCATION
- AGRAWAL B. & AGRAWAL C. M. (2012), ENGINEERING GRAPHICS, TMH PUBLICATION
- NARAYANA, K.L. & P KANNAIAH (2008), TEXT BOOK ON ENGINEERING DRAWING, SCITECHPUBLISHERS
- (CORRESPONDING SET OF) CAD SOFTWARE THEORY AND USER MANUALS

Physics (Semiconductor Physics)

PAPER CODE - 105101 || 105201

BSC PHYSICS (SEMICONDUCTOR PHYSICS)

CREDIT:5.5

MODULE 1: REVIEW OF SEMICONDUCTOR PHYSICS

E-K DIAGRAM, DENSITY OF STATES, OCCUPATION PROBABILITY, FERMI LEVEL AND QUASI-FERMI LEVEL (VARIATION BY CARRIER CONCENTRATION AND TEMPERATURE); P-N JUNCTION, METAL-SEMICONDUCTOR JUNCTION (OHMIC AND SCHOTTKY); CARRIER TRANSPORT, GENERATION, AND RECOMBINATION; SEMICONDUCTOR MATERIALS OF INTEREST FOR OPTOELECTRONIC DEVICES, BANDGAP MODIFICATION, HETEROSTRUCTURES; LIGHT- SEMICONDUCTOR INTERACTION: RATES OF OPTICAL TRANSITIONS, JOINT DENSITY OF STATES, CONDITION FOR OPTICAL AMPLIFICATION.

MODULE 2: SEMICONDUCTOR LIGHT EMITTING DIODES (LEDS)

RATE EQUATIONS FOR CARRIER DENSITY, RADIATIVE AND NON-RADIATIVE RECOMBINATION MECHANISMS IN SEMICONDUCTORS, LED: DEVICE STRUCTURE, MATERIALS, CHARACTERISTICS, AND FIGURES OF MERIT.

MODULE 3: SEMICONDUCTOR LASERS

REVIEW OF LASER PHYSICS; RATE EQUATIONS FOR CARRIER-AND PHOTON-DENSITY, AND THEIR STEADY STATE SOLUTIONS, LASER DYNAMICS, RELAXATION OSCILLATIONS, INPUT-OUTPUT CHARACTERISTICS OF LASERS. SEMICONDUCTOR LASER: STRUCTURE, MATERIALS, DEVICE CHARACTERISTICS, AND FIGURES OF MERIT; DFB, DBR, AND VERTICAL- CAVITY SURFACE-EMITTING LASERS (VECSEL), TUNABLE SEMICONDUCTOR LASERS.

MODULE 4: PHOTODETECTORS

TYPES OF SEMICONDUCTOR PHOTODETECTORS -P-N JUNCTION, PIN, AND AVALANCHE AND THEIR STRUCTURE, MATERIALS, WORKING PRINCIPLE, AND CHARACTERISTICS, NOISE LIMITS ON PERFORMANCE; SOLAR CELLS.

MODULE 5: LOW-DIMENSIONAL OPTOELECTRONIC DEVICESQUANTUM-WELL, -WIRE, AND -DOT BASED LEDS, LASERS, AND PHOTODETECTORS.

SUGGESTED TEXT/REFERENCE BOOKS

- J. SINGH, SEMICONDUCTOR OPTOELECTRONICS: PHYSICS AND TECHNOLOGY, MCGRAW- HILL INC. (1995).
- B. E. A. SALEH AND M. C. TEICH, FUNDAMENTALS OF PHOTONICS, JOHN WILEY & SONS,
- S. M. SZE, SEMICONDUCTOR DEVICES: PHYSICS AND TECHNOLOGY, WILEY (2008).
- YARIV AND P. YEH, PHOTONICS: OPTICAL ELECTRONICS IN MODERN COMMUNICATIONS, OXFORD UNIVERSITY PRESS, NEW YORK (2007).
- P. BHATTACHARYA, SEMICONDUCTOR OPTOELECTRONIC DEVICES, PRENTICE HALL OF INDIA (1997).
- ONLINE COURSE: "SEMICONDUCTOR OPTOELECTRONICS" BY M R SHENOY ON NPTEL
- ONLINE COURSE: "OPTOELECTRONIC MATERIALS AND DEVICES" BY MONICA KATIYAR AND DEEPAK GUPTA ON NPTEL

Basic Electrical Engineering

PAPER CODE - 100101 || 100201 ESC BASIC ELECTRICAL ENGINEERING

CREDIT:5

MODULE 1: DC CIRCUITS

ELECTRICAL CIRCUIT ELEMENTS (R, L AND C), VOLTAGE AND CURRENT SOURCES,

KIRCHHOFF CURRENT AND VOLTAGE LAWS, ANALYSIS OF SIMPLE CIRCUITS WITH DC

EXCITATION. STAR-DELTA CONVERSION, NETWORK THEOREMS (SUPERPOSITION, THEVENIN, NORTON AND MAXIMUM POWER TRANSFER THEOREMS). TIME-DOMAIN ANALYSIS OF FIRST-ORDER RL AND RC CIRCUITS

MODULE 2: AC CIRCUITS

REPRESENTATION OF SINUSOIDAL WAVEFORMS, PEAK, RMS AND AVERAGE VALUES (FORM

FACTOR AND PEAK FACTOR), IMPEDANCE OF SERIES AND PARALLEL CIRCUIT, PHASOR

REPRESENTATION, REAL POWER, REACTIVE POWER, APPARENT POWER, POWER FACTOR, POWER TRIANGLE. ANALYSIS OF SINGLE-PHASE AC CIRCUITS CONSISTING OF R, L, C, RL, RC, RLC COMBINATIONS (SERIES AND PARALLEL), RESONANCE.

THREE-PHASE BALANCED CIRCUITS, VOLTAGE AND CURRENT RELATIONS IN STAR AND DELTA CONNECTIONS.

MODULE 3: MAGNETIC CIRCUITS:

INTRODUCTION, SERIES AND PARALLEL MAGNETIC CIRCUITS, ANALYSIS OF SERIES AND PARALLEL MAGNETIC CIRCUITS.

MODULE 4: TRANSFORMERS

MAGNETIC MATERIALS, BH CHARACTERISTICS, IDEAL AND PRACTICAL TRANSFORMER, EMF EQUATION, EQUIVALENT CIRCUIT, LOSSES IN TRANSFORMERS, REGULATION AND EFFICIENCY. AUTO-TRANSFORMER AND THREE-PHASE TRANSFORMER CONNECTIONS.

MODULE 5: ELECTRICAL MACHINES

CONSTRUCTION, WORKING, TORQUE-SPEED CHARACTERISTIC AND SPEED CONTROL OF SEPARATELY EXCITED DC MOTOR. GENERATION OF ROTATING MAGNETIC FIELDS, CONSTRUCTION AND WORKING OF A THREE-PHASE INDUCTION MOTOR, SIGNIFICANCE OF TORQUE-SLIP CHARACTERISTIC. LOSS COMPONENTS AND EFFICIENCY, STARTING AND SPEED CONTROL OF INDUCTION MOTOR. CONSTRUCTION AND WORKING OF SYNCHRONOUS GENERATORS.

MODULE 6: ELECTRICAL INSTALLATIONS

COMPONENTS OF LT SWITCHGEAR: SWITCH FUSE UNIT (SFU), MCB, ELCB, MCCB, TYPES OF WIRES AND CABLES, EARTHING. TYPES OF BATTERIES, IMPORTANT CHARACTERISTICS FOR BATTERIES. ELEMENTARY CALCULATIONS FOR ENERGY CONSUMPTION,

POWER FACTOR IMPROVEMENT AND BATTERY BACKUP.

SUGGESTED TEXT / REFERENCE BOOKS

- D. P. KOTHARI AND I. J. NAGRATH, "BASIC ELECTRICAL ENGINEERING", TATA MCGRAW HILL, 2010.
- D. C. KULSHRESHTHA, "BASIC ELECTRICAL ENGINEERING", MCGRAW HILL, 2009.
- L. S. BOBROW, "FUNDAMENTALS OF ELECTRICAL ENGINEERING", OXFORD UNIVERSITY PRESS, 2011.

- E. HUGHES, "ELECTRICAL AND ELECTRONICS TECHNOLOGY", PEARSON, 2010.
- V. D. TORO, "ELECTRICAL ENGINEERING FUNDAMENTALS", PRENTICE HALL INDIA, 1989.
- BASIC ELECTRICAL ENGINEERING BY FITZERALD, ET AL, TATA MCGRAW HILL
- FUNDAMENTALS OF ELECTRICAL ENGG. BY R. PRASAD, PHI PUBLICATION
- BASIC ELECTRICAL ENGINEERING BY V.K. MEHTA AND ROHIT MEHTA, S.CHAND PUBLICATION

Mathematics -II (Probability and Statistics)

MATHEMATICS -II (PROBABILITY AND STATISTICS)

CREDIT - 04

MODULE 1: BASIC PROBABILITY

PROBABILITY SPACES, CONDITIONAL PROBABILITY, INDEPENDENCE; DISCRETE RANDOM VARIABLES, INDEPENDENT RANDOM VARIABLES, THE MULTINOMIAL DISTRIBUTION, POISSON APPROXIMATION TO THE BINOMIAL DISTRIBUTION, INFINITE SEQUENCES OF BERNOULLI TRIALS, SUMS OF INDEPENDENT RANDOM VARIABLES; EXPECTATION OF DISCRETE RANDOM VARIABLES, MOMENTS, VARIANCE OF A SUM, CORRELATION COEFFICIENT, CHEBYSHEV'S INEQUALITY.

MODULE 2: CONTINUOUS PROBABILITY DISTRIBUTIONS CONTINUOUS RANDOM VARIABLES AND THEIR PROPERTIES, DISTRIBUTION FUNCTIONS AND DENSITIES, NORMAL, EXPONENTIAL AND GAMMA DENSITIES.

MODULE 3: BIVARIATE DISTRIBUTIONS

BIVARIATE DISTRIBUTIONS AND THEIR PROPERTIES, DISTRIBUTION OF SUMS AND QUOTIENTS, CONDITIONAL DENSITIES, BAYES' RULE.

MODULE 4: BASIC STATISTICS

MEASURES OF CENTRAL TENDENCY: MOMENTS, SKEWNESS AND KURTOSIS - PROBABILITY DISTRIBUTIONS: BINOMIAL, POISSON AND NORMAL - EVALUATION OF STATISTICAL

PARAMETERS FOR THESE THREE DISTRIBUTIONS, CORRELATION AND REGRESSION - RANK CORRELATION.

MODULE 5: APPLIED STATISTICS

CURVE FITTING BY THE METHOD OF LEAST SQUARES- FITTING OF STRAIGHT LINES, SECOND DEGREE PARABOLAS AND MORE GENERAL CURVES. TEST OF SIGNIFICANCE: LARGE SAMPLE TEST FOR SINGLE PROPORTION, DIFFERENCE OF PROPORTIONS, SINGLE MEAN, DIFFERENCE OF MEANS AND DIFFERENCE OF STANDARD DEVIATIONS.

MODULE 6: SMALL SAMPLES

TEST FOR SINGLE MEAN, DIFFERENCE OF MEANS AND CORRELATION COEFFICIENTS, TEST FOR RATIO OF VARIANCES - CHI-SQUARE TEST FOR GOODNESS OF FIT AND INDEPENDENCE OF ATTRIBUTES.

TEXT / REFERENCES:

- 1.E. KREYSZIG, "ADVANCED ENGINEERING MATHEMATICS", JOHN WILEY & SONS, 2006.
- 2.P. G. HOEL, S. C. PORT AND C. J. STONE, "INTRODUCTION TO PROBABILITY THEORY", UNIVERSAL BOOK STALL, 2003.
- 3. S. ROSS, "A FIRST COURSE IN PROBABILITY", PEARSON EDUCATION INDIA, 2002.
- 4.W. FELLER, "AN INTRODUCTION TO PROBABILITY THEORY AND ITS APPLICATIONS", VOL. 1, WILEY, 1968.
- 5. N.P. BALI AND M. GOYAL, "A TEXT BOOK OF ENGINEERING MATHEMATICS", LAXMI PUBLICATIONS, 2010.
- 6.B.S. GREWAL, "HIGHER ENGINEERING MATHEMATICS", KHANNA PUBLISHERS, 2000.
- 7.T. VEERARAJAN, "ENGINEERING MATHEMATICS", TATA MCGRAW-HILL, NEW DELHI, 2010

